

# HSF

Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

### NOTES:

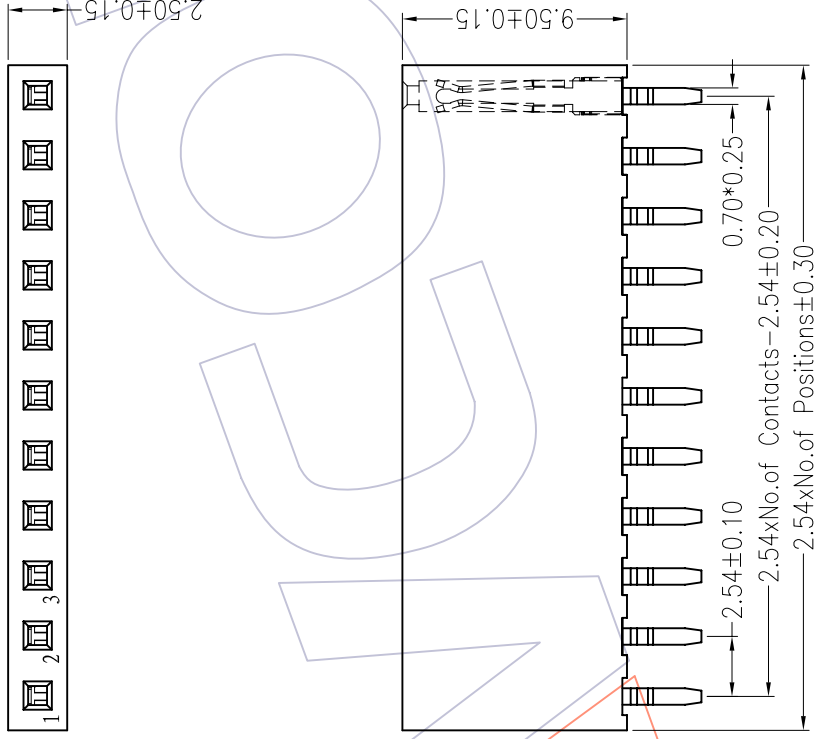
Rated Current:3.0AMP  
Contact Resistance:20mΩ max  
Withstand Voltage:1000V AC/DC  
Insulation Resistance:1000MΩ min  
Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze  
Contact Plating:Au or Sn Over Ni  
Insulator Material:PA6T/PBT+30%G.F(UL94V-0)

## Ordering Information

2195 - 1 XX S XX X UN X 1

No. of Pins Per 02-40P	Contact Plating G0=Gold Flash G1=3u"Gold G2=5u"Gold G3=10u"Gold G4=15u"Gold G5=30u"Gold S0=Gold Flash/Tin S1=3u"Gold/Tin S2=5u"Gold/Tin S3=10u"Gold/Tin S4=15u"Gold/Tin S5=30u"Gold/Tin SN=Tin	Insulator C=PA6T A=PBT	Packing A=Tray T=Tube
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1 2 3 4 5 6 7 8 9 10

A B C D E F G H

								09.02.13	SCALE 1:1	WAVE HARDWARE ELECTRONICS CO.,LTD
								UNIT mm	mm	2195-1XXSXXUNX1
								SIZE A4	A4	PART NO.
A0	09/02/13							SHEET 1/1	1/1	TITLE: FH2.54 SINGLE ROW 180° II=9.50
REV	DATE	MODIFICATION	DESCRIPTION	CHANGE	APPROVE	APPROVE	APPROVE	DIM	±.3'	Customer NO.

## WCON 维峰五金电子有限公司

WAVE HARDWARE ELECTRONICS CO.,LTD

PART NO. 2195-1XXSXXUNX1

TITLE: FH2.54 SINGLE ROW 180° II=9.50

Customer NO.

1 2 3 4 5 6 7 8 9 10